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We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

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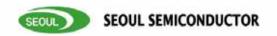
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

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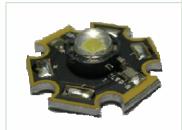




# X42182

Z-Power series is designed for high current operation and high flux output applications.

emission material.



Z-Power LED's thermal management perform exceeds other power LED solutions.

It incorporates state of the art SMD design and Thermal

Z Power LED is ideal light sources for general illumination applications, custom designed solutions, automotive large LCD backlights

# X42182

#### **Features**

- Super high flux output and high luminance
- Designed for high current operation
- · Low thermal resistance
- SMT solderability
- · Lead free product
- RoHS compliant

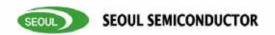
# **Applications**

- Mobile phone flash
- Automotive interior / Exterior lighting
- · Automotive signal lighting
- Automotive forward lighting
- Torch
- · Architectural lighting
- · LCD TV / Monitor backlight
- Projector light source
- · Traffic signals
- · Task lighting
- Decorative / Pathway lighting
- Remote / Solar powered lighting
- · Household appliances

Rev. U4

November, 2009

<sup>\*</sup> The appearance and specifications of the product may be changed for improvement without notice.



# Full Code of Z-Power LED Series

Full code form :  $X_1 X_2 X_3 X_4 X_5 X_6 - X_7 X_8 - X_9 X_{10} X_{11} X_{12} X_{13}$ 

#### 1. Part Number

- X<sub>1</sub>: Color

- X<sub>2</sub>: Z-Power LED series number

- X<sub>3</sub>: LENS type

- X<sub>4</sub>: Chip quantity (or Power Dissipation)

- X<sub>5</sub>: Package outline size

- X<sub>6</sub>: Type of PCB

#### 2. Internal Number

- X7: Grade of characteristic code

- X<sub>8</sub>

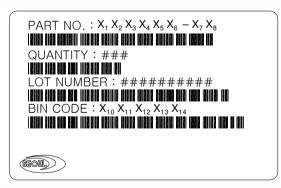
#### 3. Code Labeling

- X<sub>9</sub>: Luminous flux (or Radiant flux for royal blue)

-  $X_{10} X_{11} X_{12}$ : Dominant wavelength (or x,y coordinates rank code)

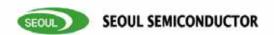
- X<sub>13</sub>: Forward voltage

### 4. Sticker Diagram on Reel & Aluminum Vinyl Bag



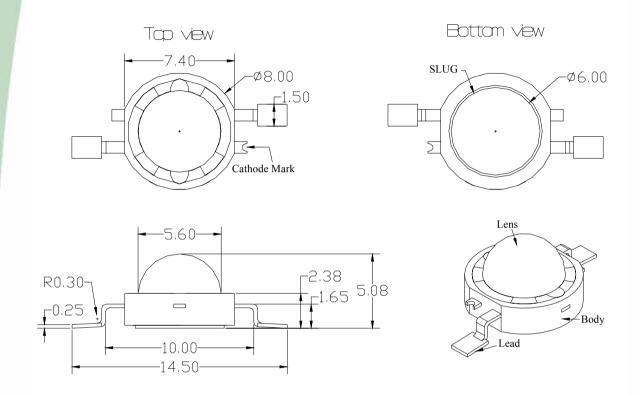
For more information about binning and labeling, refer to the Application Note -1

Document No.: SSC-QP-7-07-24 (Rev.00)



### **Outline Dimension**

# 1. Dome Type



#### Notes:

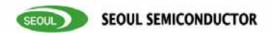
- 1. All dimensions are in millimeters. (tolerance :  $\pm 0.2$ )
- 2. Scale: none
- 3. Slug of package is connected to anode.

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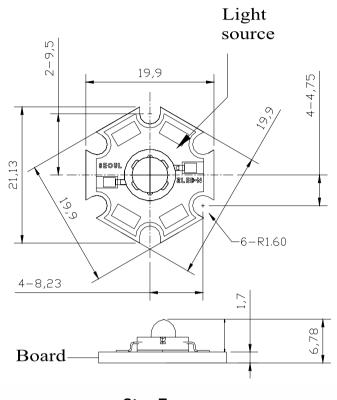
3

<sup>\*</sup> The appearance and specifications of the product may be changed for improvement without notice.



# **Outline Dimension**

# 2. PCB Type



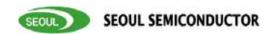
# Star Type

#### Notes

- 1. All dimensions are in millimeters. (tolerance :  $\pm 0.2$ )
- 2. Scale: none
- \* The appearance and specifications of the product may be changed for improvement without notice.

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#### 1. Pure White (W42182)

1-1 Electro-Optical characteristics at  $I_F=350 \, \text{mA}$ ,  $T_A=25^{\circ} \, \text{C}$ 

Parameter		Symbol	Value			llmit
Parameter	- arameter		Min	Тур	Max	Unit
Luminous Flux [1]	T rank	Φ <sub>V</sub> <sup>[2]</sup>	70	80	91	lm
Luminous Flux <sup>[1]</sup>	U rank	Φ <sub>V</sub> <sup>[2]</sup>	91	100	-	lm
Correlated Color Temper	ature <sup>[3]</sup>	CCT	-	6300	-	К
CRI		$R_a$	-	75	-	-
Forward Voltage <sup>[</sup>	4]	V <sub>F</sub>	3.0	3.25	4	V
View Angle		2⊖ ½		127		deg.
Thermal resistance [5]		R⊖ <sub>J-B</sub>	8.8			ºC/W
Thermal resistance	[6]	R⊖ <sub>J-C</sub>		7.2		ºC/W

#### 1-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I_	1000 (@ Tj = 90 ºC) [7]	m A
Torward Gurrent	l <sub>F</sub>	1800 (@ 1KHz, 1/10 duty)	IIIA
Power Dissipation	$P_d$	4	W
Junction Temperature	$T_{j}$	145(@ I <sub>F</sub> ≤700mA)	ō C
Operating Temperature	$T_{opr}$	-40 ~ +85	ō C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	ō C
ESD Sensitivity [8]	-	±10,000V HBM	-

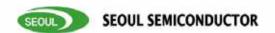
#### \* Notes:

- [1] SSC maintains a tolerance of  $\pm 10\%$  on flux and power measurements.
- [2]  $\Phi_V$  is the total luminous flux output as measured with an integrated sphere.
- [3] Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. CCT  $\pm 5\%$  tester tolerance.
  - [4] A tolerance of  $\pm 0.06$ V on forward voltage measurements
  - [5], [6]  $R\Theta_{J-B}$  is measured with a SSC metal core pcb.(25  $^{\circ}C \leq T_{J} \leq 110 \,^{\circ}C$ )  $R\Theta_{J-C}$  is measured with only emitter. (25  $^{\circ}C \leq T_{J} \leq 110 \,^{\circ}C$ ) Break voltage of Metal PCB is 6.5kVAC.
  - [7]  $I_F$  Max is guaranteed under the  $T_J \leq 90$   ${}^{\circ}$  C.
  - [8] It is included the zener chip to protect the product from ESD.

-----Caution-----

1. Please do not drive at rated current more than 5 sec. without proper heat sink.

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#### 2. Warm White (N42182)

2-1 Electro-Optical characteristics at  $I_F=350 \, m\, A$ ,  $T_A=25^{\circ}\, C$ 

Parameter	Symbol	Value			llmit
Parameter		Min	Тур	Max	Unit
Luminous Flux <sup>[1]</sup>	Φ <sub>V</sub> <sup>[2]</sup>	-	66	-	lm
Correlated Color Temperature <sup>[3]</sup>	CCT	-	3000	-	К
CRI	$R_a$	-	93	-	-
Forward Voltage <sup>[4]</sup>	$V_{F}$	3.0	3.25	4	V
View Angle	2⊝ 1/2	124		deg.	
Thermal resistance <sup>[5]</sup>	R⊖ <sub>J-B</sub>	8.8		ºC/W	
Thermal resistance <sup>[6]</sup>	R⊖ <sub>J-C</sub>		7.2		º C /W

#### 2-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I <sub>F</sub>	800	m A
Power Dissipation	$P_d$	3.2	W
Junction Temperature	T <sub>j</sub>	145	ō C
Operating Temperature	$T_{opr}$	-40 ~ +85	º C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	ō C
ESD Sensitivity [7]	-	±10,000V HBM	-

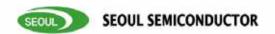
#### \* Notes:

- [1] SSC maintains a tolerance of  $\pm 10\%$  on flux and power measurements.
- [2]  $\Phi_{V}$  is the total luminous flux output as measured with an integrated sphere.
- [3] Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. CCT  $\pm 5\%$  tester tolerance
- [4] A tolerance of  $\pm 0.06 \, \text{V}$  on forward voltage measurements
- [5], [6]  $R\Theta_{J-B}$  is measured with a SSC metal core pcb.(25  ${}^{\circ}C \le T_{J} \le 110 {}^{\circ}C$ )  $R\Theta_{J-C}$  is measured with only emitter. .(25  ${}^{\circ}C \le T_{J} \le 110 {}^{\circ}C$ ) Break voltage of Metal PCB is 6.5kVAC
- [7] It is included the zener chip to protect the product from ESD.

-----Caution-----

1. Please do not drive at rated current more than 5 sec. without proper heat sink

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#### 3. Warm White (N42182H)

3-1 Electro-Optical characteristics at  $I_F=350 \, \text{mA}$ ,  $T_A=25^{\circ} \, \text{C}$ 

Beremeter	Cum h a l	Value			Unit
Parameter	Symbol	Min	Тур	Max	Unit
Luminous Flux <sup>[1]</sup>	Φ <sub>V</sub> <sup>[2]</sup>	-	77	-	lm
Correlated Color Temperature [3]	CCT	-	3000	-	K
CRI	$R_a$	-	80	-	-
Forward Voltage <sup>[4]</sup>	$V_{F}$	3.0	3.25	4	V
View Angle	2⊝ 1/2	124		deg.	
Thermal resistance [5]	R⊖ <sub>J-B</sub>	8.8		º C /W	
Thermal resistance [6]	R⊖ <sub>J-C</sub>		7.2		º C /W

#### 3-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I <sub>F</sub>	800	m A
Power Dissipation	$P_d$	3.2	W
Junction Temperature	T <sub>j</sub>	145	ō C
Operating Temperature	$T_{opr}$	-40 ~ +85	º C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	ō C
ESD Sensitivity [7]	-	±10,000V HBM	-

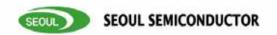
#### \* Notes:

- [1] SSC maintains a tolerance of  $\pm 10\%$  on flux and power measurements.
- [2]  $\Phi_{V}$  is the total luminous flux output as measured with an integrated sphere.
- [3] Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. CCT  $\pm 5\%$  tester tolerance
- [4] A tolerance of  $\pm 0.06 \, \text{V}$  on forward voltage measurements
- [5], [6]  $R\Theta_{J-B}$  is measured with a SSC metal core pcb.(25  ${}^{\circ}C \le T_{J} \le 110 {}^{\circ}C$ )  $R\Theta_{J-C}$  is measured with only emitter. .(25  ${}^{\circ}C \le T_{J} \le 110 {}^{\circ}C$ ) Break voltage of Metal PCB is 6.5kVAC
- [7] It is included the zener chip to protect the product from ESD.

-----Caution-----

1. Please do not drive at rated current more than 5 sec. without proper heat sink

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#### 4. Natural White (S42182)

4-1 Electro-Optical characteristics at I<sub>F</sub>= 350mA, T<sub>A</sub>= 25°C

Parameter	Cumbal	Value			Unit
Farameter	Symbol	Min	Тур	Max	Ollit
Luminous Flux <sup>[1]</sup>	Φ <sub>V</sub> <sup>[2]</sup>	ı	72	-	lm
Correlated Color Temperature <sup>[3]</sup>	CCT	-	4000	-	К
CRI	$R_a$	-	93	-	-
Forward Voltage <sup>[4]</sup>	$V_{F}$	3.0	3.25	4	V
View Angle	2⊝ 1/2	124		deg.	
Thermal resistance <sup>[5]</sup>	R⊖ <sub>J-B</sub>	8.8		ºC/W	
Thermal resistance <sup>[6]</sup>	R⊖ <sub>J-C</sub>		7.2		ºC/W

#### 4-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I <sub>F</sub>	800	m A
Power Dissipation	$P_d$	3.2	W
Junction Temperature	T <sub>j</sub>	145	ō C
Operating Temperature	$T_{opr}$	-40 ~ +85	ō C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	ō C
ESD Sensitivity [8]	-	±10,000V HBM	-

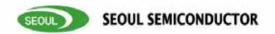
#### \* Notes:

- [1] SSC maintains a tolerance of  $\pm 10\%$  on flux and power measurements.
- [2]  $\Phi_{V}$  is the total luminous flux output as measured with an integrated sphere.
- [3] Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. CCT  $\pm 5\%$ 
  - [4] A tolerance of ±0.06V on forward voltage measurements
  - [5], [6]  $R\Theta_{J-B}$  is measured with a SSC metal core pcb.(25  $^{\circ}C \leq T_{J} \leq 110 \,^{\circ}C$ )  $R\Theta_{J-C}$  is measured with only emitter. (25  $^{\circ}C \leq T_{J} \leq 110 \,^{\circ}C$ ) Break voltage of Metal PCB is 6.5kVAC.
  - [7] It is included the zener chip to protect the product from ESD.

#### -----Caution-----

1. Please do not drive at rated current more than 5 sec. without proper heat sink

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#### 5. Natural White (S42182H)

5-1 Electro-Optical characteristics at  $I_F=350 \, \text{mA}$ ,  $T_A=25^{\circ} \, \text{C}$ 

Parameter	Cumbal	Value			Umit
Parameter	Symbol	Min	Тур	Max	Unit
Luminous Flux [1]	$\Phi_{V}^{[2]}$	-	84	-	lm
Correlated Color Temperature [3]	CCT	-	4000	-	K
CRI	$R_a$	-	80	-	-
Forward Voltage <sup>[4]</sup>	V <sub>F</sub>	3.0	3.25	4	V
View Angle	2⊝ 1/2	124		deg.	
Thermal resistance [5]	R⊖ <sub>J-B</sub>	8.8			ºC/W
Thermal resistance [6]	R⊖ <sub>J-C</sub>		7.2		ºC/W

#### 5-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I <sub>F</sub>	800	m A
Power Dissipation	$P_d$	3.2	W
Junction Temperature	T <sub>j</sub>	145	ō C
Operating Temperature	$T_{opr}$	-40 ~ +85	ō C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	ō C
ESD Sensitivity [8]	-	±10,000V HBM	-

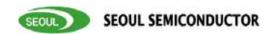
#### \* Notes:

- [1] SSC maintains a tolerance of  $\pm 10\%$  on flux and power measurements.
- [2]  $\Phi_{V}$  is the total luminous flux output as measured with an integrated sphere.
- [3] Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. CCT  $\pm 5\%$ 
  - [4] A tolerance of ±0.06V on forward voltage measurements
  - [5], [6]  $R\Theta_{J-B}$  is measured with a SSC metal core pcb.(25  $^{\circ}C \leq T_{J} \leq 110 \,^{\circ}C$ )  $R\Theta_{J-C}$  is measured with only emitter. (25  $^{\circ}C \leq T_{J} \leq 110 \,^{\circ}C$ ) Break voltage of Metal PCB is 6.5kVAC.
  - [7] It is included the zener chip to protect the product from ESD.

-----Caution-----

1. Please do not drive at rated current more than 5 sec. without proper heat sink

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#### 6. Blue (B42182)

6-1 Electro-Optical characteristics at I<sub>E</sub>= 350mA, T<sub>A</sub>= 25°C

Parameter	Cum h a l	Value			Unit
Parameter	Symbol	Min	Тур	Max	Unit
Luminous Flux <sup>[1]</sup>	Φ <sub>V</sub> <sup>[2]</sup>	-	22	-	lm
Dominant Wavelength <sup>[3]</sup>	$\lambda_{D}$	455	465	475	nm
Forward Voltage [4]	$V_{F}$	3.0	3.25	4	V
View Angle	2⊝ 1/2		130		deg.
Thermal resistance [5]	R⊖ <sub>J-B</sub>	8.8			ºC/W
Thermal resistance <sup>[6]</sup>	$R\Theta_{J-C}$		7.2		ºC/W

#### 6-2 Absolute Maximum Ratings

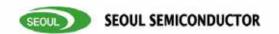
Parameter	Symbol	Value	Unit
Forward Current	I <sub>F</sub>	1000	m A
Power Dissipation	$P_d$	4	W
Junction Temperature	T <sub>j</sub>	145	ō C
Operating Temperature	$T_{opr}$	-40 ~ +85	ō C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	ō C
ESD Sensitivity [7]	-	±10,000V HBM	-

#### \* Notes:

- [1] SSC maintains a tolerance of  $\pm 10\%$  on flux and power measurements.
- [2]  $\Phi_{\text{V}}$  is the total luminous flux output as measured with an integrated sphere.
- [3] Dominant wavelength is derived from the CIE 1931 Chromaticity diagram. A tolerance of  $\pm 0.5$ nm for dominant wavelength
- [4] A tolerance of  $\pm 0.06$ V on forward voltage measurements
- [5], [6]  $R\Theta_{J-B}$  is measured with a SSC metal core pcb.(25  ${}^{\circ}C \leq T_{J} \leq 110 {}^{\circ}C$ )  $R\Theta_{J\text{-}C}$  is measured with only emitter. .(25  $^{\circ}C \leq T_{J} \leq$  110  $^{\circ}C)$ Break voltage of Metal PCB is 6.5kVAC
- [7] It is included the zener chip to protect the product from ESD.

#### -----Caution-----

- 1. Please do not drive at rated current more than 5 sec. without proper heat sink
- 2. Blue power light sources represented here are IEC825 Class 2 for eye safety



#### 7. Royal Blue (D42182)

7-1 Electro-Optical characteristics at I<sub>F</sub>= 350mA, T<sub>A</sub>= 25°C

Parameter	Cumbal		Unit		
Parameter	Symbol	Min	Тур	Max	Unit
Radiant Power [1]	Φ <sub>V</sub> <sup>[2]</sup>	-	468	-	m W
Dominant Wavelength $^{[3]}$ $\lambda_l$		455	457	460	nm
Forward Voltage <sup>[4]</sup>	$V_{F}$	3.0	3.25	3.8	V
View Angle	2⊝ 1/2	130		deg.	
Thermal resistance <sup>[5]</sup>	$R\Theta_{J-B}$	8.8		ºC/W	
Thermal resistance <sup>[6]</sup>	R⊖ <sub>J-C</sub>		7.2		ºC/W

#### 7-2 Absolute Maximum Ratings

Parameter	Symbol Value		Unit
Forward Current	I <sub>F</sub>	1000	m A
Power Dissipation	P <sub>d</sub>	4	W
Junction Temperature	T <sub>j</sub>	145	ō C
Operating Temperature	$T_{opr}$	-40 ~ +85	ō C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	ō C
ESD Sensitivity [7]	-	±10,000V HBM	-

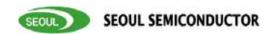
#### \* Notes:

- [1] SSC maintains a tolerance of  $\pm 10\%$  on flux and power measurements.
- [2]  $\Phi_V$  is the total luminous flux output as measured with an integrated sphere.
- [3] Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. CCT  $\pm 5\%$  tester tolerance
- [4] A tolerance of  $\pm 0.06$ V on forward voltage measurements
- [5], [6]  $R\Theta_{J-B}$  is measured with a SSC metal core pcb.(25  $^{\circ}C \leq T_{J} \leq$  110  $^{\circ}C$ )  $R\Theta_{J-C}$  is measured with only emitter. .(25  $^{\circ}C \leq T_{J} \leq$  110  $^{\circ}C$ ) Break voltage of Metal PCB is 6.5kVAC
- [7] It is included the zener chip to protect the product from ESD.

#### -----Caution------

- 1. Please do not drive at rated current more than 5 sec. without proper heat sink
- 2. Blue power light sources represented here are I EC825 Class 2 for eye safety

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#### 8. Green (G42182)

8-1 Electro-Optical characteristics at I<sub>E</sub>= 350mA, T<sub>A</sub>= 25°C

Parameter	Cumbal		llmit		
Parameter	Symbol	Min	Тур	Max	Unit
Luminous Flux <sup>[1]</sup>	$\Phi_{V}^{[2]}$	-	70	-	lm
Dominant Wavelength <sup>[3]</sup>	ength <sup>[3]</sup> $\lambda_D$ 520 525 53		535	nm	
Forward Voltage <sup>[4]</sup>	V <sub>F</sub>	3.0	3.25	4.1	V
View Angle	2⊝ 1/2	130		deg.	
Thermal resistance <sup>[5]</sup>	$R\Theta_{J-B}$	9.5		ºC/W	
Thermal resistance [6]	R⊖ <sub>J-C</sub>		8.0		ºC/W

#### 8-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I <sub>F</sub>	1000	m A
Power Dissipation	$P_d$	4	W
Junction Temperature	T <sub>j</sub>	145	ō C
Operating Temperature	$T_{opr}$	-40 ~ +85	ōC
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	ōC
ESD Sensitivity [7]	-	±10,000V HBM	-

#### \* Notes:

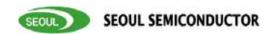
- [1] SSC maintains a tolerance of  $\pm 10\%$  on flux and power measurements.
- [2]  $\Phi_V$  is the total luminous flux output as measured with an integrated sphere.
- [3] Dominant wavelength is derived from the CIE 1931 Chromaticity diagram. A tolerance of  $\pm 0.5$ nm for dominant wavelength
- [4] A tolerance of  $\pm 0.06V$  on forward voltage measurements
- [5], [6]  $R\Theta_{J-B}$  is measured with a SSC metal core pcb.(25  $^{\circ}C \le T_{J} \le 110 \,^{\circ}C$ )  $R\Theta_{J-C}$  is measured with only emitter. .(25  $^{\circ}C \le T_{J} \le 110 \,^{\circ}C$ ) Break voltage of Metal PCB is 6.5kVAC
- [7] It is included the zener chip to protect the product from ESD.

Caution
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1. Please do not drive at rated current more than 5 sec. without proper heat sin

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#### 9. Red (R42182)

9-1 Electro-Optical characteristics at  $I_F=350 \, \text{mA}$ ,  $T_A=25^{\circ} \, \text{C}$ 

Baramatar	Cumbal		llm:4		
Parameter	Symbol	Min	Тур	Max	Unit
Luminous Flux <sup>[1]</sup>	Φ <sub>V</sub> <sup>[2]</sup>	-	48	-	lm
Dominant Wavelength <sup>[3]</sup>	$\lambda_{D}$	618 625		630	nm
Forward Voltage [4]	$V_{F}$	2.0	2.3	3.0	V
View Angle	2⊝ 1/2	130		deg.	
Thermal resistance [5]	$R\Theta_{J-B}$	9		ºC/W	
Thermal resistance [6]	R⊖ <sub>J-C</sub>		7.8		ºC/W

#### 9-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I <sub>F</sub>	800	m A
Power Dissipation	$P_d$	2.4	W
Junction Temperature	T <sub>j</sub>	145	ō C
Operating Temperature	$T_{opr}$	-40 ~ +85	ō C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	ō C
ESD Sensitivity [7]	-	±10,000V HBM	-

#### \* Notes:

- [1] SSC maintains a tolerance of  $\pm 10\%$  on flux and power measurements.
- [2]  $\Phi_V$  is the total luminous flux output as measured with an integrated sphere.
- [3] Dominant wavelength is derived from the CIE 1931 Chromaticity diagram. A tolerance of  $\pm 0.5$ nm for dominant wavelength
- [4] A tolerance of  $\pm 0.06V$  on forward voltage measurements
- [5], [6]  $R\Theta_{J\text{-}B}$  is measured with a SSC metal core pcb.(25  $^{\circ}C \leq T_{J} \leq$  110  $^{\circ}C$ )  $R\Theta_{J\text{-}C}$  is measured with only emitter. .(25  $^{\circ}C \leq T_{J} \leq$  110  $^{\circ}C$ ) Break voltage of Metal PCB is 6.5kVAC
- [7] It is included the zener chip to protect the product from ESD.

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1. Please do not drive at rated current more than 5 sec. without proper heat sink

Rev. 04

November, 2009

Document No.: SSC-QP-7-07-24 (Rev.00)



#### 10. Amber (A42182)

10-1 Electro-Optical characteristics at  $I_F=350 \, \text{mA}$ ,  $T_A=25^{\circ} \, \text{C}$ 

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Parameter	Symbol	Min	Тур	Max	Unit
Luminous Flux <sup>[1]</sup>	Φ <sub>V</sub> <sup>[2]</sup>	-	48	-	lm
Dominant Wavelength <sup>[3]</sup>	$\lambda_{D}$	585	590	595	nm
Forward Voltage [4]	V <sub>F</sub>	2.0	2.3	3.0	V
View Angle	2⊝ 1/2	130		deg.	
Thermal resistance <sup>[5]</sup>	$R\Theta_{J-B}$	9			ºC/W
Thermal resistance [6]	R⊖ <sub>J-C</sub>		7.8		ºC/W

#### 10-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I <sub>F</sub>	800	m A
Power Dissipation	$P_d$	2.4	W
Junction Temperature	T <sub>j</sub>	145	ō C
Operating Temperature	$T_{opr}$	-40 ~ +85	ō C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	ō C
ESD Sensitivity [7]	-	±10,000V HBM	-

#### \* Notes:

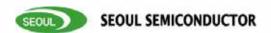
- [1] SSC maintains a tolerance of  $\pm 10\%$  on flux and power measurements.
- [2]  $\Phi_{\text{V}}$  is the total luminous flux output as measured with an integrated sphere.
- [3] Dominant wavelength is derived from the CIE 1931 Chromaticity diagram. A tolerance of  $\pm 0.5$ nm for dominant wavelength
- [4] A tolerance of  $\pm 0.06V$  on forward voltage measurements
- [5], [6]  $R\Theta_{J-B}$  is measured with a SSC metal core pcb.(25  $^{\circ}C \le T_{J} \le 110 \,^{\circ}C$ )  $R\Theta_{J-C}$  is measured with only emitter. .(25  $^{\circ}C \le T_{J} \le 110 \,^{\circ}C$ ) Break voltage of Metal PCB is 6.5kVAC
- [7] It is included the zener chip to protect the product from ESD.

Caution								
			_				_	

1. Please do not drive at rated current more than 5 sec. without proper heat sink

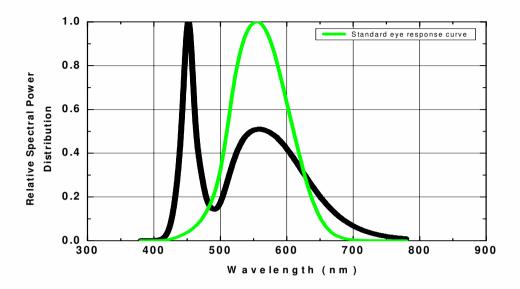
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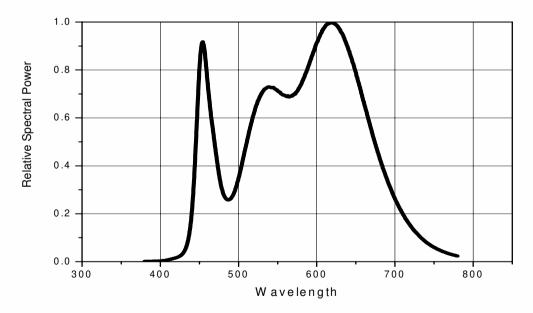


# Color Spectrum, $T_A = 25^{\circ}C$

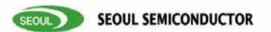
### 1. Pure White



# 2. Warm White (N42182)

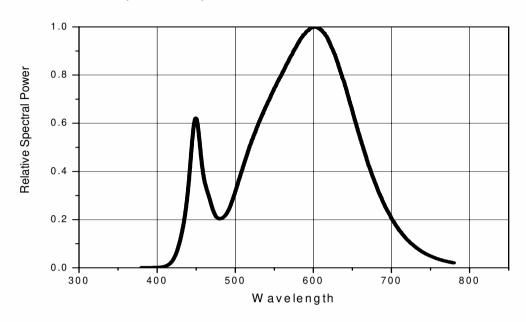


Rev. 04

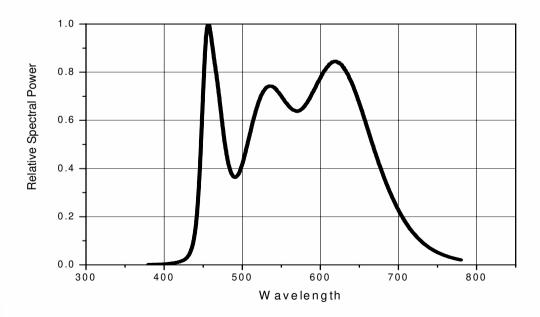


# Color Spectrum, T<sub>A</sub>= 25°C

# 3. Warm White (N42182H)



# 4. Natural White (S42182)



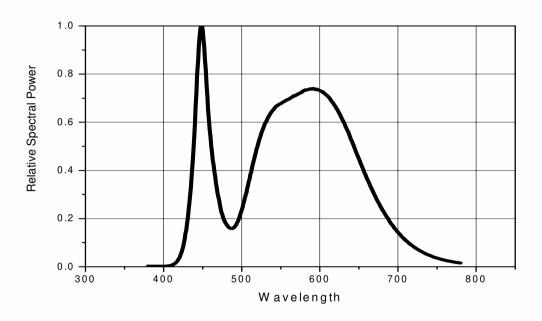
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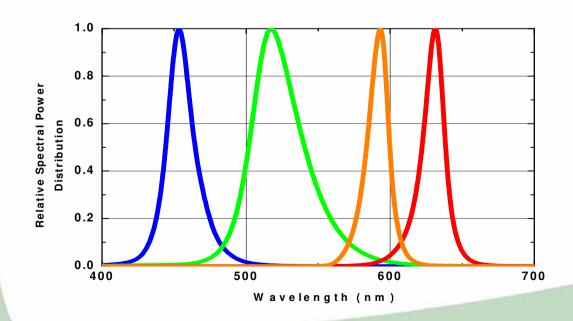


# Color Spectrum, T<sub>A</sub>= 25°C

# 5. Natural White (S42182H)



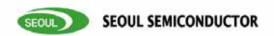
### 5. Red, Amber, Green, Blue(Royal Blue)



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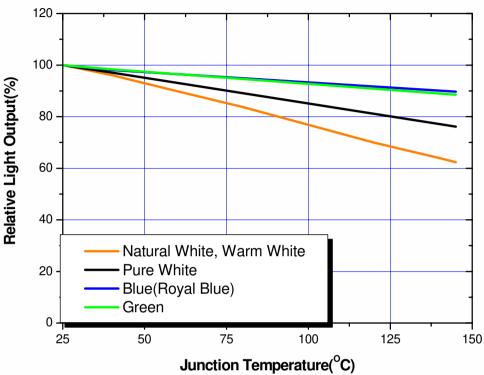
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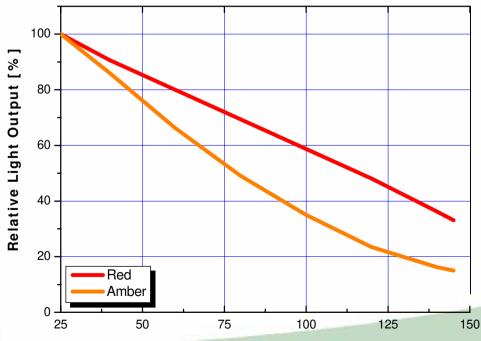
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# **Junction Temperature Characteristics**

# 1. Relative Light Output vs. Junction Temperature at I $_{\rm F}$ = 350 mA

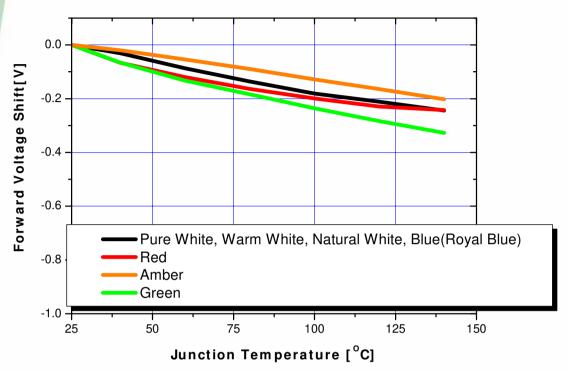




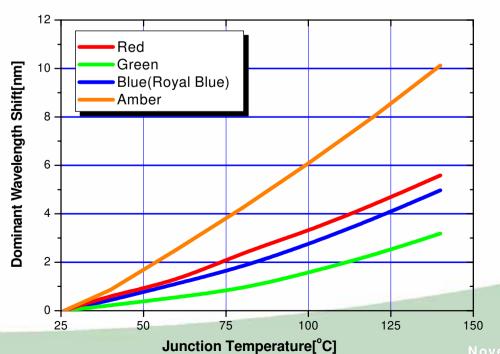
Junction Temperature [°C]

# **Junction Temperature Characteristics**

### 2. Forward Voltage Shift vs. Junction Temperature at $I_F = 350 \text{ mA}$



# 3. Wavelength Shift vs Junction Temperature at $I_F = 350 \, \text{mA}$

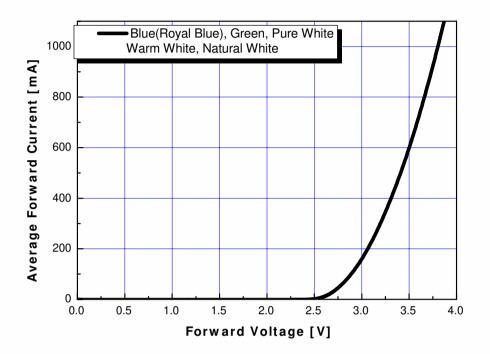


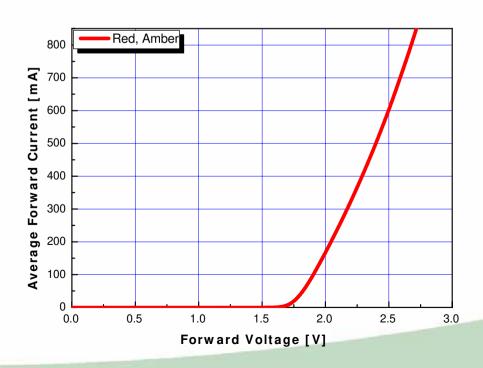
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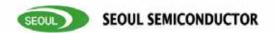
### **Forward Current Characteristics**

# 1. Forward Voltage vs. Forward Current , $T_A = 25$ $^{\circ}$ c



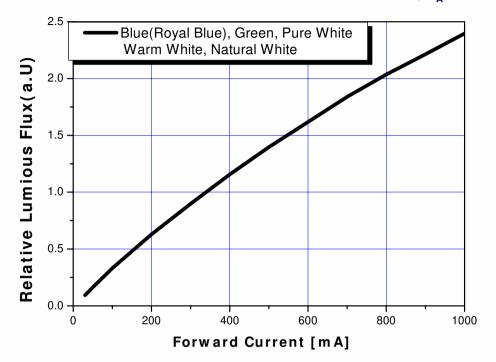


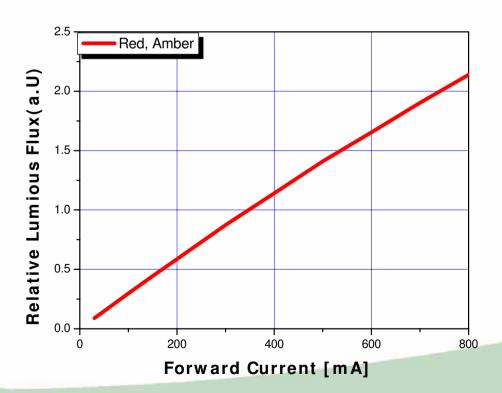
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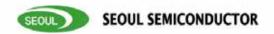
#### **Forward Current Characteristics**

# 2. Forward Current vs. Normalized Relative Luminous Flux, T<sub>A</sub>= 25 °c



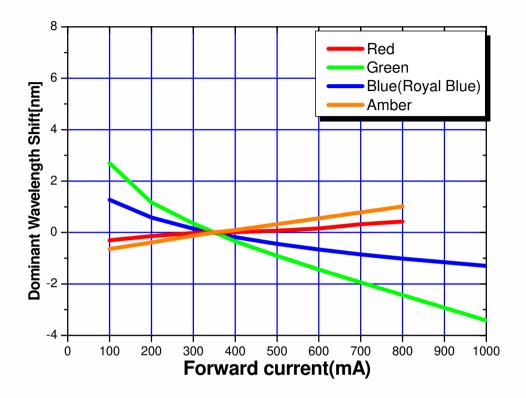


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# **Forward Current Characteristics**

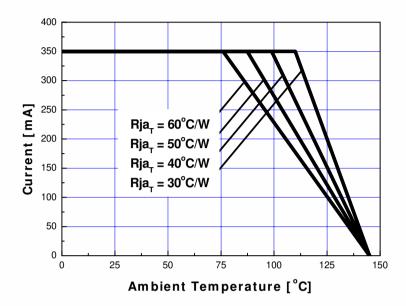
# 3. Forward Current vs Wavelength Shift, T<sub>A</sub>= 25 °c



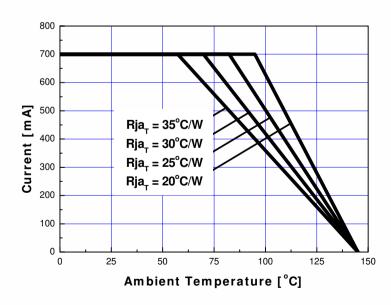
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# **Ambient Temperature vs Allowable Forward Current**

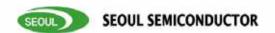
# 1-1. Pure White, Warm White, Natural White, Green, Blue(Royal Blue) (T<sub>JMAX</sub> = 145 °C, @350 mA)



# 1-2. Pure White, Warm White, Natural White, Green, Blue(Royal Blue) (T<sub>JMAX</sub> = 145 °C, @700mA)

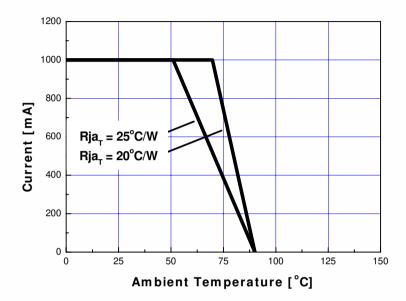


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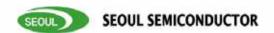


# **Ambient Temperature vs Allowable Forward Current**

1-3. Pure White, Green, Blue(Royal Blue)  $(T_{JMAX} = 90 \, ^{\circ}\text{C}, \text{ at } 1000\text{mA})$ 

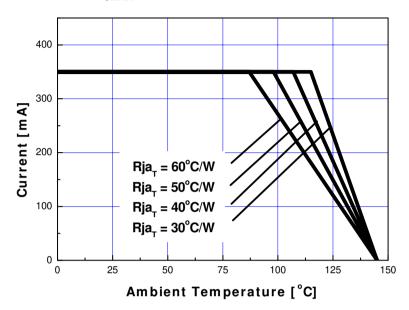


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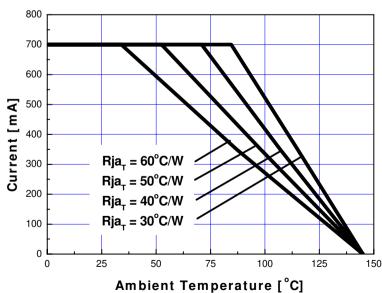


# **Ambient Temperature vs Allowable Forward Current**

# 1-4. Red, Amber $(T_{JMAX} = 145 \, {}^{\circ}\text{C}, \text{ at } 350 \,\text{mA})$



# 1-5. Red, Amber $(T_{JMAX} = 145 \, {}^{\circ}\text{C}, \, @700 \, \text{mA})$



Rev. 04